



06-23-2003



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U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office
Docket No. 0756-7110

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Atsuo ISOBE; Shunpei YAMAZAKI; Koji DAIRIKI;
Hiroshi SHIBATA; Chiho KOKUBO; Tatsuya ARAO;
Masahiko HAYAKAWA; Hidekazu MIYAIRI;
Akihisa SHIMOMURA; Koichiro TANAKA;
Mai AKIBAAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: 05/10/2003; 05/28/2003; 05/30/2003;
05/24/2003; 05/30/2003; 05/10/2003; 05/10/2003;
05/10/2003; 05/10/2003; 05/10/2003; 05/10/2003

2. Name and address of receiving party(ies)

Name: Semiconductor Energy Laboratory Co., Ltd.

Internal Address: _____

Street Address: 398, HaseAtsugi-shiCity: Kanagawa-ken State: _____ Zip: _____Country: Japan Postal Code: 243-0036Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s);

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

10/338,043

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Attorney Name: Eric J. RobinsonFirm Name: Robinson Intellectual Property Law OfficeInternal Address: PMB 955Street Address: 21010 Southbank Street,City: Potomac Falls State: VA Zip: 201657. Total number of applications and patents involved: 1

8. Total fee (37 CFR 3.41).....\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

6. Submission Type

- ☒ New
☐ Resubmission (Non-Recordation)
Document ID# _____
☐ Correction of PTO Error
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☐ Corrective Document
Reel # _____ Frame # _____

9. Deposit account number:

50-2280

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10. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Eric J. Robinson, Reg. No. 38,285

Name of Person Signing

Signature

June 16, 2003

Date

Total number of pages including cover sheet, attachments, and documents: 3

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on June 16, 2003.

Adeline M. StampsMail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

06/19/2003 MBERHE 00000052 10338043

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PATENT
REEL: 014185 FRAME: 0364

ASSIGNMENT

Serial No. 10/338,043

Filed January 8, 2003

WHEREAS, Atsuo ISOBE, Shunpei YAMAZAKI, Koji DAIRIKI, Hiroshi SHIBATA, Chiho KOKUBO, Tatsuya ARAO, Masahiko HAYAKAWA, Hidekazu MIYAIRI, Akihisa SHIMOMURA, Koichiro TANAKA, Mai AKIBA (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE PRODUCTION SYSTEM for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein

hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of ROBINSON INTELLECTUAL PROPERTY LAW OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 05/10/2003 Signature Atsuo Isobe
Name Atsuo ISOBE

Date 05/28/2003 Signature Shunpei Yamazaki
Name Shunpei YAMAZAKI

Date 05/30/2003 Signature Koji Dairiki
Name Koji DAIRIKI

Date 05/28/2003 Signature Hiroshi Shibata
Name Hiroshi SHIBATA

Date 05/30/2003 Signature Chiho Kokubo
Name Chiho KOKUBO

Date 05/10/2003 Signature Tatsuya Arai
Name Tatsuya ARAO

Date 05/10/2003

Signature Masahiko Hayakawa
Name Masahiko HAYAKAWA

Date 05/10/2003

Signature Hidekazu MIYAIRI
Name Hidekazu MIYAIRI

Date 05/10/2003

Signature Akihisa SHIMOMURA
Name Akihisa SHIMOMURA

Date 05/10/2003

Signature Koichiro TANAKA
Name Koichiro TANAKA

Date 05/10/2003

Signature Mai Akiba
Name Mai AKIBA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.

Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____

ASSIGNMENT

Serial No. 10/338,043

Filed January 8, 2003

WHEREAS, Atsuo ISOBE, Shunpei YAMAZAKI, Koji DAIRIKI, Hiroshi SHIBATA, Chiho KOKUBO, Tatsuya ARAO, Masahiko HAYAKAWA, Hidekazu MIYAIRI, Akihisa SHIMOMURA, Koichiro TANAKA, Mai AKIBA (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE PRODUCTION SYSTEM for which an application for Letters Patent of the United States of America has been executed by the undersigned on _____, and;

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Name Koji DAIRIKI

Date 05/28/2003 Signature Hiroshi Shibata
Name Hiroshi SHIBATA

Date 05/30/2003 Signature Chiho Kokubo
Name Chiho KOKUBO

Date 05/10/2003 Signature Tatsuya ARAO
Name Tatsuya ARAO

Date 05/10/2003

Signature Masahiko Hayakawa
Name Masahiko HAYAKAWA

Date 05/10/2003

Signature Hidekazu MIYAIRI
Name Hidekazu MIYAIRI

Date 05/10/2003

Signature Akihisa SHIMOMURA
Name Akihisa SHIMOMURA

Date 05/10/2003

Signature Koichiro TANAKA
Name Koichiro TANAKA

Date 05/10/2003

Signature Mai Akiba
Name Mai AKIBA

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Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____